

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE30H11BG uses advanced trench technology and design to provide excellent $R_{\text{DS}(\text{ON})}$ with low gate charge. It can be used in a wide variety of applications.

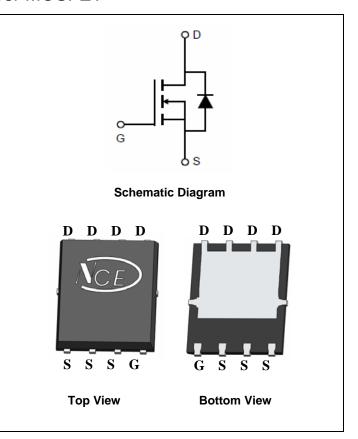
General Features

- V_{DS} =30V, I_D =110A $R_{DS(ON)}$ =2.3mΩ (typical) @ V_{GS} =10V $R_{DS(ON)}$ =3.3mΩ (typical) @ V_{GS} =4.5V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 150 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

100% UIS TESTED! 100% ΔVds TESTED!



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE30H11BG	NCE30H11BG	DFN5X6-8L	-	-	-

Absolute Maximum Ratings (T_A=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	30	V
Gate-Source Voltage	V _G s	±20	V
Drain Current-Continuous	I _D	110	А
Drain Current-Continuous(T _C =100°C)	I _D (100℃)	77.8	Α
Pulsed Drain Current	I _{DM}	440	Α
Maximum Power Dissipation	P _D	68	W
Single pulse avalanche energy (Note 5)	E _{AS}	350	mJ
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 150	$^{\circ}$

Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	R _{eJC}	1.83	°C/W
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Electrical Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	·					
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	30	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	·					
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1	1.6	2.5	٧
Drain-Source On-State Resistance	Б	V _{GS} =10V, I _D =20A	-	2.3	3.0	mΩ
Dialii-Source Oii-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =20A		3.3	4.1	
Forward Transconductance	9 FS	V _{DS} =5V,I _D =20A	50	-	-	S
Dynamic Characteristics (Note4)	·					
Input Capacitance	C _{lss}	\/ -15\/\/ -0\/		3009		PF
Output Capacitance	Coss	V_{DS} =15V, V_{GS} =0V, F=1.0MHz		451		PF
Reverse Transfer Capacitance	C _{rss}	r-1.UIVIAZ		403		PF
Switching Characteristics (Note 4)	·					
Turn-on Delay Time	t _{d(on)}		-	20	-	nS
Turn-on Rise Time	t _r	V_{DD} =15 V , I_D =20 A	-	15	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =4.5 V , R_{GEN} =1.8 Ω	-	60	-	nS
Turn-Off Fall Time	t _f		-	10	-	nS
Total Gate Charge	Qg	\/ -4F\/ -20A		66.3		nC
Gate-Source Charge	Q _{gs}	V _{DS} =15V,I _D =20A,		7.0		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V		17.2		nC
Drain-Source Diode Characteristics	<u>.</u>		•			•
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =20A	-	-	1.2	V
Diode Forward Current (Note 2)	Is	-	-	-	110	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 20A	-	56	-	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	110	-	nC

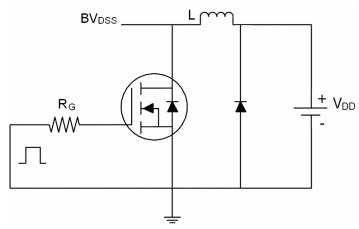
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- **4.** Guaranteed by design, not subject to production
- **5.** EAS condition: Tj=25 $^{\circ}\text{C}$,VDD=15V,VG=10V,L=0.5mH,Rg=25 Ω

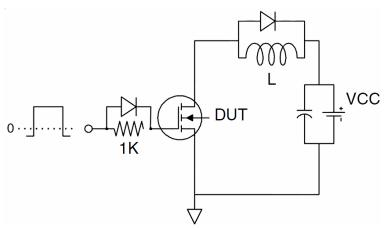


Test circuit

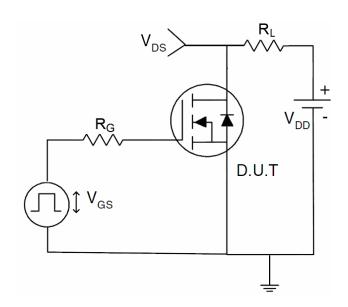
1) E_{AS} test Circuits



2) Gate charge test Circuit:



3) Switch Time Test Circuit:





Typical Electrical and Thermal Characteristics (Curves)

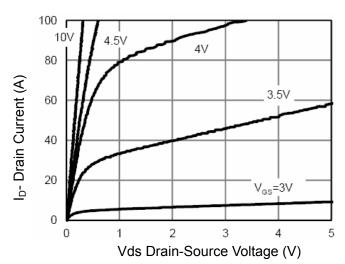


Figure 1 Output Characteristics

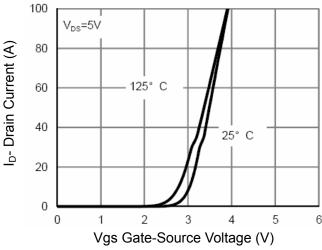


Figure 2 Transfer Characteristics

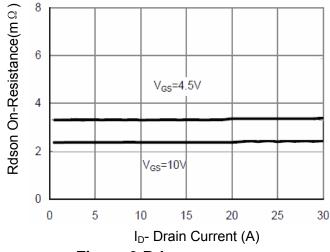


Figure 3 Rdson- Drain Current

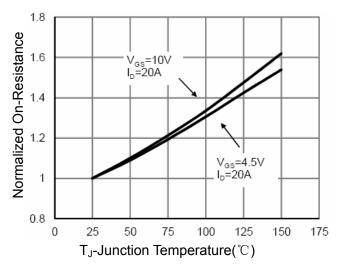


Figure 4 Rdson-JunctionTemperature

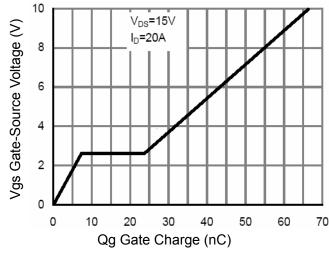


Figure 5 Gate Charge

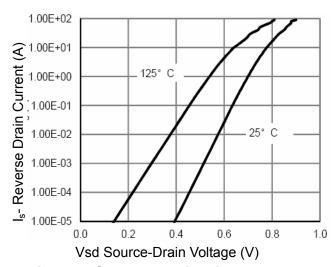


Figure 6 Source- Drain Diode Forward



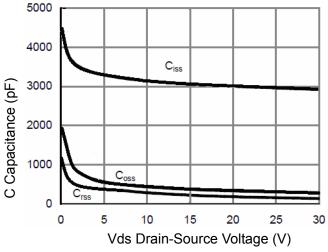


Figure 7 Capacitance vs Vds

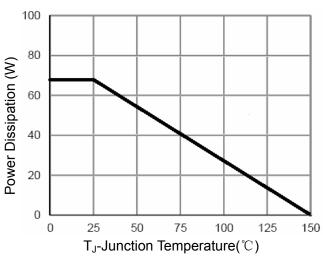


Figure 9 Power De-rating

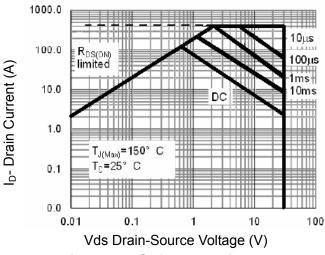


Figure 8 Safe Operation Area

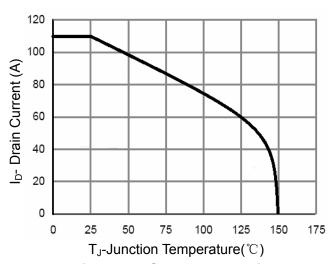


Figure 10 Current De-rating

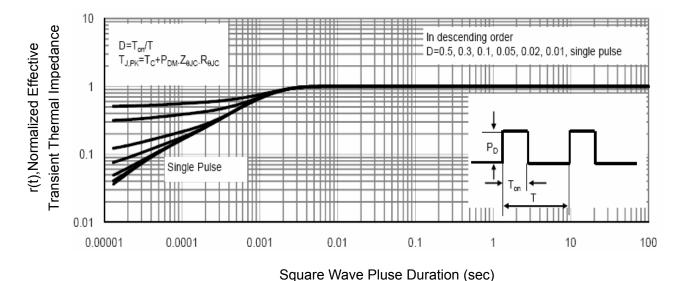
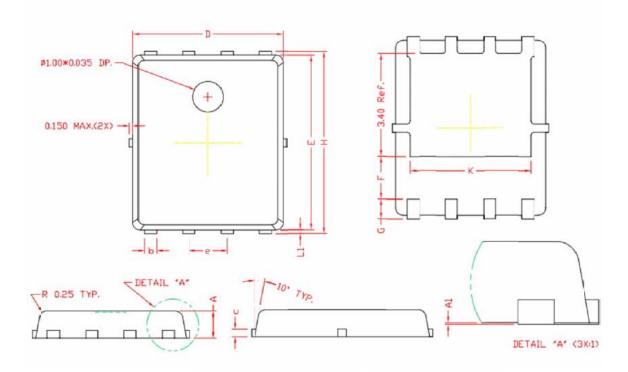


Figure 11 Normalized Maximum Transient Thermal Impedance



DFN5X6-8L Package Information



COMMON DIMENSIONS

(UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	NOM	MAX	
A	0.80	0.90	1.00	
A1	0.00	0.03	0.05	
b	0.35	0.42	0.49	
С	0. 254 REF.			
D	4.90	5.00	5. 10	
F	1. 40 REF.			
E	5. 70	5. 80	5. 90	
е	1. 27 BSC.			
Н	5. 95	6.08	6. 20	
L1	0.10	0.14	0.18	
G	0. 60 REF.			
K	4. 00 REF.			



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